

SEMICONDUCTOR®

September 2008

FDMA410NZ

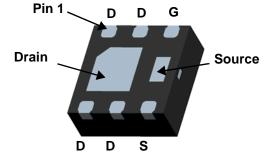
Single N-Channel 1.5 V Specified PowerTrench[®] MOSFET 20 V, 9.5 A, 23 m Ω

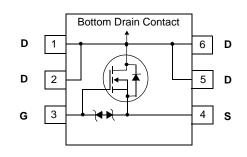
Features

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- Max $r_{DS(on)}$ = 23 m Ω at V_{GS} = 4.5 V, I_D = 9.5 A
- Max $r_{DS(on)}$ = 29 m Ω at V_{GS} = 2.5 V, I_D = 8.0 A
- Max $r_{DS(on)}$ = 36 m Ω at V_{GS} = 1.8 V, I_D = 4.0 A
- Max $r_{DS(on)}$ = 50 m Ω at V_{GS} = 1.5 V, I_D = 2.0 A
- HBM ESD protection level > 2.5 kV (Note 3)
- Low Profile-0.8 mm maximum in the new package MicroFET 2x2 mm
- RoHS Compliant







This Single N-Channel MOSFET has been designed using

Fairchild Semiconductor's advanced Power Trench process to

optimize the $r_{DS(ON)}$ @ V_{GS} = 1.5 V on special MicroFET

General Description

leadframe.

Applications

Li-lon Battery Pack

MicroFET 2X2 (Bottom View)

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			20	V	
V _{GS}	Gate to Source Voltage			±8	V	
ID	-Continuous	T _A = 25 °C	(Note 1a)	9.5		
	-Pulsed			24	— A	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.4	- w	
	Power Dissipation	T _A = 25 °C	(Note 1b)	0.9		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	52	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1b)	145	C/VV

Package Marking and Ordering Information

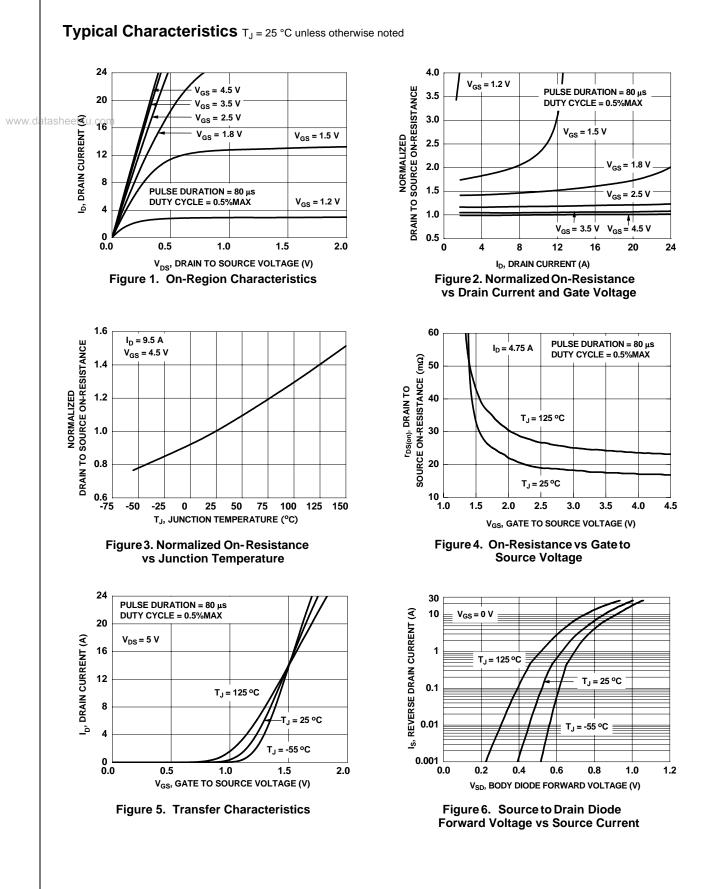
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
410	FDMA410NZ	MicroFET 2X2	7 "	12 mm	3000 units

Off Chara BV _{DSS}		Test Conditions	Min	Тур	Max	Units
BVDSS	acteristics					·
000	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		17		mV/°
heet4u.com	Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
On Chara	octeristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	0.4	0.7	1.0	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage					
ΔT_J	Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-3		mV/°
		$V_{GS} = 4.5 \text{ V}, \ I_D = 9.5 \text{ A}$		17	23	_
		$V_{GS} = 2.5 \text{ V}, \ I_D = 8.0 \text{ A}$		20	29	
(DC(an)	Static Drain to Source On Resistance	$V_{GS} = 1.8 \text{ V}, \ I_D = 4.0 \text{ A}$		24	36	mΩ
^r DS(on)		$V_{GS} = 1.5 \text{ V}, \ I_D = 2.0 \text{ A}$		29	50	
		$V_{GS} = 4.5 \text{ V}, I_D = 9.5 \text{ A},$ $T_J = 125 ^{\circ}\text{C}$		23	32	
9 _{FS}	Forward Transconductance	$V_{DD} = 5 V, I_D = 9.5 A$		35		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			815	1080	pF
C _{oss}	Output Capacitance	V _{DS} = 10 V, V _{GS} = 0 V,		130	175	pF
	Reverse Transfer Capacitance	f = 1 MHz		85	130	pF
U						P .
C _{rss} R _g	Gate Resistance	f = 1 MHz		2.1		Ω
R _g Switching	Gate Resistance g Characteristics Turn-On Delay Time	f = 1 MHz		2.1 7.5	15	Ω
×	g Characteristics			<u> </u>	15 10	
R _g Switching t _{d(on)} t _r	g Characteristics Turn-On Delay Time	f = 1 MHz V _{DD} = 10 V, I _D = 9.5 A, V _{GS} = 4.5 V, R _{GEN} = 6 Ω		7.5		ns
R _g Switching t _{d(on)}	g Characteristics Turn-On Delay Time Rise Time	V _{DD} = 10 V, I _D = 9.5 A,		7.5 3.9	10	ns ns
$\frac{R_g}{\textbf{Switching}} \\ \frac{t_{d(on)}}{t_r} \\ \frac{t_{d(off)}}{t_f} \\ t_f \\ \label{eq:result}$	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	V_{DD} = 10 V, I _D = 9.5 A, V _{GS} = 4.5 V, R _{GEN} = 6 Ω		7.5 3.9 27	10 44	ns ns ns ns
$\begin{array}{c} {\sf R}_{\sf g} \\ \hline {\sf Switching} \\ \hline {\sf t}_{\sf d(on)} \\ {\sf t}_{\sf r} \\ \hline {\sf t}_{\sf d(off)} \\ {\sf t}_{\sf f} \\ \hline {\sf Q}_{\sf g} \end{array}$	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DD} = 10$ V, $I_D = 9.5$ A, $V_{GS} = 4.5$ V, $R_{GEN} = 6$ Ω $V_{GS} = 4.5$ V, $V_{DD} = 10$ V,		7.5 3.9 27 3.7	10 44 10	ns ns ns
$\begin{array}{c} R_g \\ \hline \textbf{Switching} \\ \hline t_{d(on)} \\ t_r \\ \hline t_{d(off)} \\ t_f \\ \hline Q_g \\ \hline Q_{gs} \\ \end{array}$	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	V_{DD} = 10 V, I _D = 9.5 A, V _{GS} = 4.5 V, R _{GEN} = 6 Ω		7.5 3.9 27 3.7 10	10 44 10	ns ns ns ns nC
$\begin{array}{c} R_g \\ \hline \\ \textbf{Switching} \\ \hline t_{d(on)} \\ t_r \\ \hline t_{d(off)} \\ \hline t_f \\ \hline Q_g \\ \hline Q_{gs} \\ \hline Q_{gd} \\ \hline \end{array}$	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{DD} = 10$ V, $I_D = 9.5$ A, $V_{GS} = 4.5$ V, $R_{GEN} = 6$ Ω $V_{GS} = 4.5$ V, $V_{DD} = 10$ V,		7.5 3.9 27 3.7 10 1.2	10 44 10	ns ns ns nC nC
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 9.5 \text{ A},$ $V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 4.5 \text{ V}, \text{ V}_{DD} = 10 \text{ V},$ $I_{D} = 9.5 \text{ A}$		7.5 3.9 27 3.7 10 1.2	10 44 10	ns ns ns nC nC
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$V_{DD} = 10 \text{ V}, I_{D} = 9.5 \text{ A},$ $V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 4.5 \text{ V}, V_{DD} = 10 \text{ V},$ $I_{D} = 9.5 \text{ A}$		7.5 3.9 27 3.7 10 1.2	10 44 10 14	ns ns ns nC nC
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge urce Diode Characteristics Maximum Continuous Drain-Source Diode	$V_{DD} = 10 \text{ V}, I_{D} = 9.5 \text{ A},$ $V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 4.5 \text{ V}, V_{DD} = 10 \text{ V},$ $I_{D} = 9.5 \text{ A}$		7.5 3.9 27 3.7 10 1.2 2.0	10 44 10 14 2.0	ns ns ns nC nC A

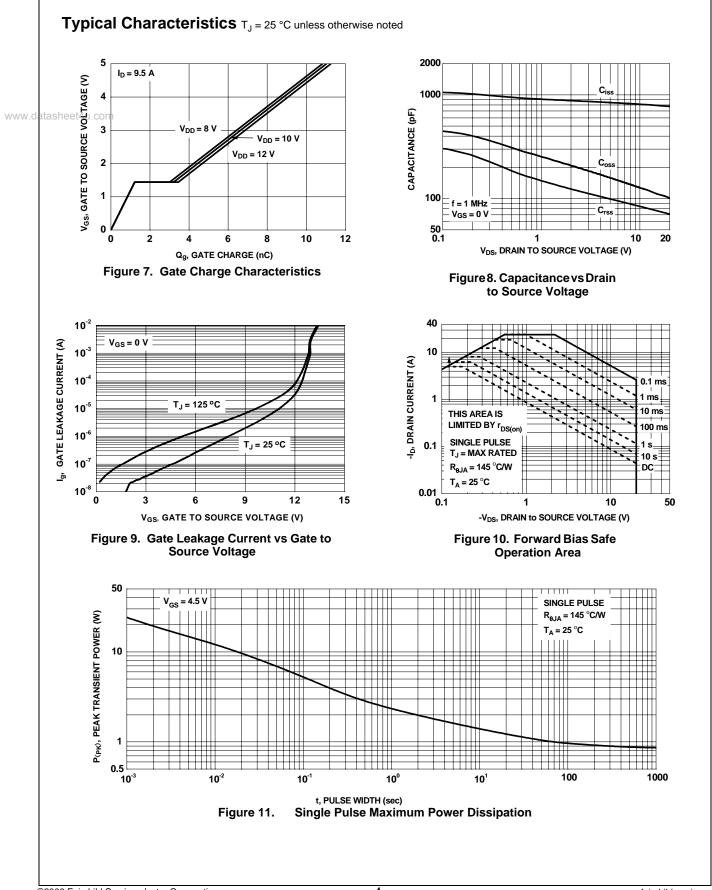
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Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
 The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

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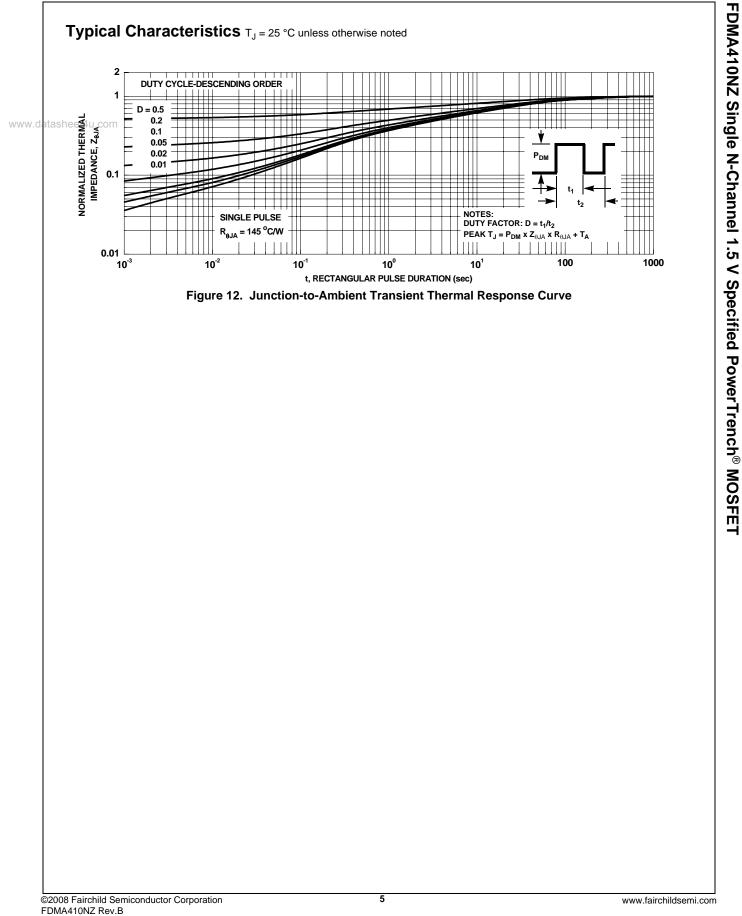


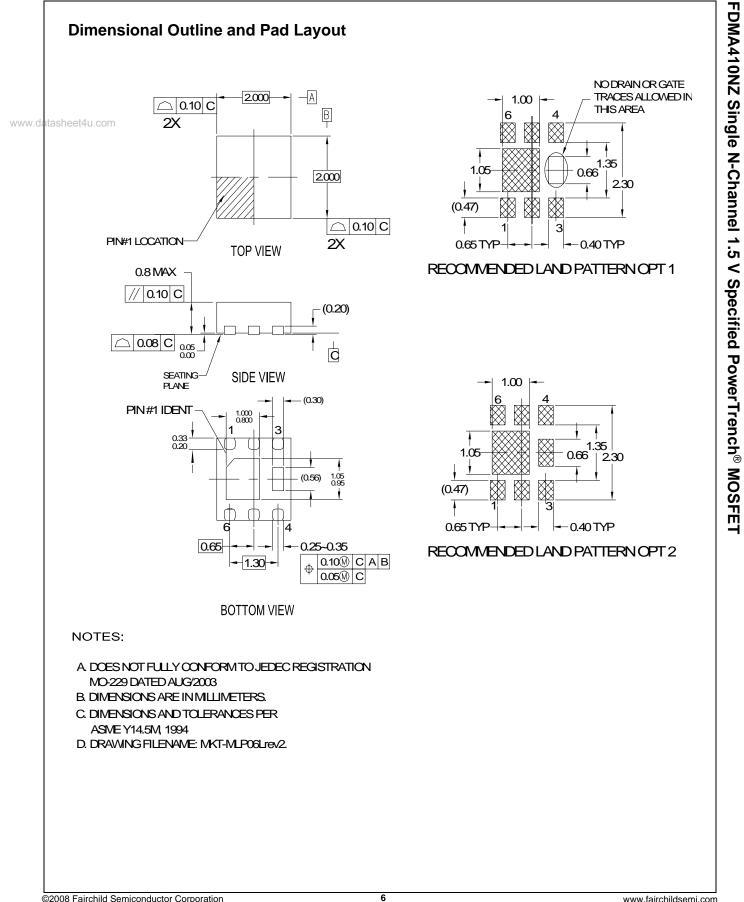
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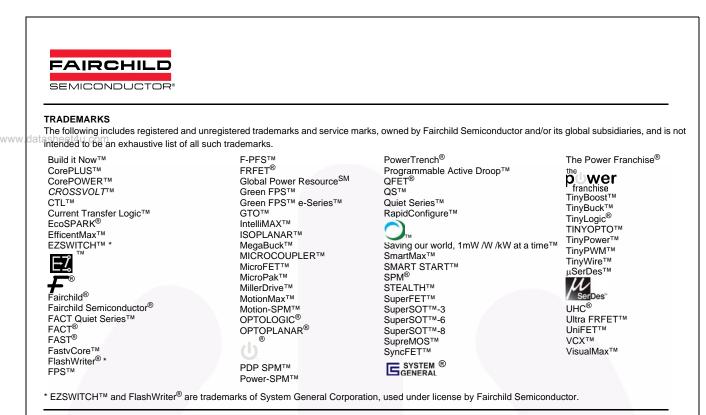


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